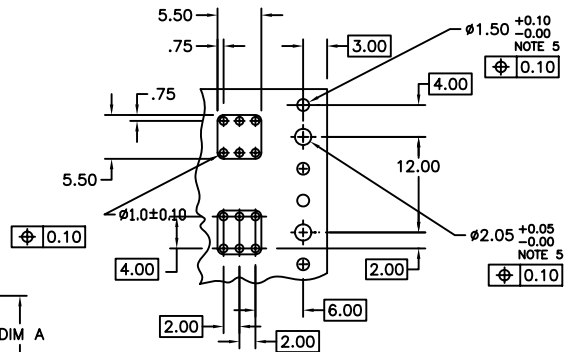
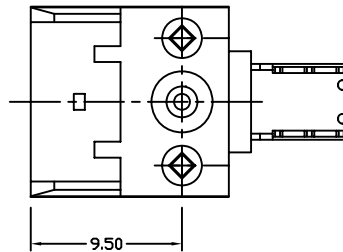
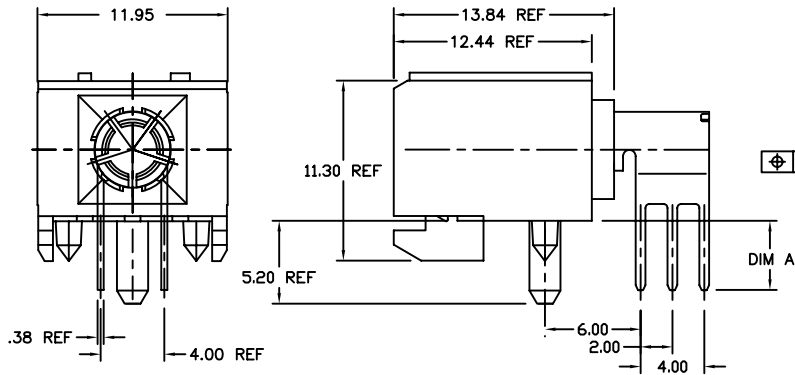


PRODUCT NO.	PCB THICKNESS	DIM A
70424-002	2.4	3.5
70424-003	1.6	2.7
70424-002LF	2.4	3.5
70424-003LF	1.6	2.7



RECOMMENDED PC BOARD
HOLE PATTERN
(COMPONENT SIDE)

NOTES:

- BODY MATERIAL: LCP, 30% GLASS-FILLED, FLAME RETARDANT, ACC, UL94-V0
- TERMINAL MATERIAL: BeCu
- PLATING SOLDER TAILS: FOR 70424-0XX SnPb
FOR 70424-0XXLF Sn (LEAD FREE)
- PLATING CONTACT AREA: 0.80µm Au OVER 1.3µm Ni.
- INDICATED HOLES ARE UNPLATED
- PRODUCT MARKETING: PART NUMBER & BATCH I.D.
- THE PRODUCTS WHERE THE PART NUMBER ENDS IN "LF" MEET THE EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- ALL PRODUCTS WILL WITHSTAND EXPOSURE TO 260° FOR 60 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.

mat'l code				surface ASME Y14.5 ✓		tolerance ASME Y14.5		projection 		product family METRAL (tm)			
ltr	ecr no	dr	date	tolerances unless otherwise specified						title			
A	V61323	SAR	1996-09-03	angles	linear	X #3		scale 1:1		POWER CONNECT. ASS'Y W/ METRAL HSG 70292			
B	V61725	SAR	1996-11-18			XX #13							
C	V81212	MDF	1998-06-17			0° ±.2° XXX #.051							
D	V01598	JWS	200-07-12	dr	S. ROYER 1996-09-03				dwg no		sheet 1 of 1	size	
E	V05-0778	JRV	2005-08-15	engr	C. PENDLETON 1996-09-03				70424		A4		
F	V06-0606	JRV	2006-06-20	chr	C. PENDLETON 1996-09-03								
				appd					type		CUSTOMER Drawing		
sheet index	revision	sheet	F	1									